

## MPSA05/MMBTA05

### **NPN General Purpose Amplifier**

- This device is designed for general purpose amplifier applications at collector currents to 300mA.
- Sourced from process 10.





1. Emitter 2. Base 3. Collector 1. Base 2. Emitter 3. Collector

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	60	V
V <sub>CBO</sub>	Collector-Base Voltage	60	V
V <sub>EBO</sub>	Emitter-Base Voltage	4.0	V
I <sub>C</sub>	Collector current - Continuous	500	mA
T <sub>J</sub> , T <sub>stg</sub>	Junction and Storage Temperature	-55 ~ +150	°C

### Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Characte	Off Characteristics					
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage *	$I_{C} = 1 \text{mA}, I_{B} = 0$	60			V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_C = 100\mu A, I_C = 0$	4			V
I <sub>CEO</sub>	Collector Cutoff Current	$V_{CE} = 60V, I_{B} = 0$			0.1	μΑ
I <sub>CBO</sub>	Emitter Cutoff Current	$V_{CB} = 60V, I_{E} = 0$			0.1	μΑ
On Characteristics						
h <sub>FE</sub>	DC Current Gain	I <sub>C</sub> = 10mA, V <sub>CE</sub> = 1.0V I <sub>C</sub> = 100mA, V <sub>CE</sub> = 1.0V	100 100			
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 100mA, I <sub>B</sub> = 10mA			0.25	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	I <sub>C</sub> = 100mA, V <sub>CE</sub> = 1.0V			1.2	V
Small Signal Characteristics						
f <sub>T</sub>	Current Gain Bandwidth Product	I <sub>C</sub> = 10mA, V <sub>CE</sub> = 2V, f = 100MHz	100			MHz

<sup>\*</sup> Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%

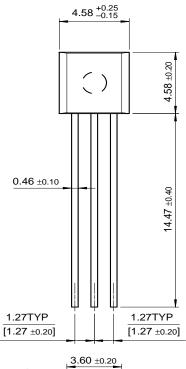
### Thermal Characteristics T<sub>A</sub>=25°C unless otherwise noted

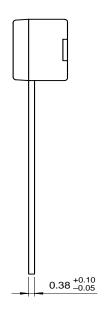
Symbol	Parameter	Ma	Lheite	
		MPSA05	*MMBTA05	Units
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5	350 2.8	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

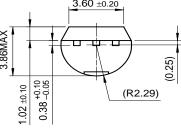
<sup>\*</sup> Device mounted on FR-4 PCB 1.6" × 0.06"

## **Package Dimensions**

TO-92

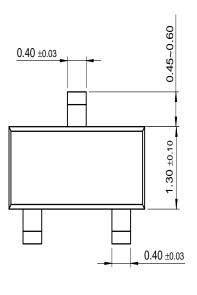


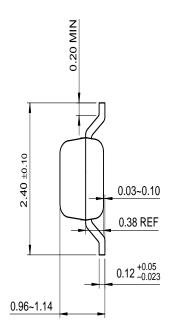


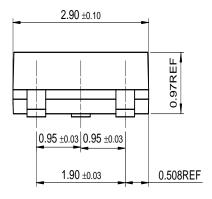


## Package Dimensions (Continued)

## **SOT-23**







Dimensions in Millimeters

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EnSigna™	I <sup>2</sup> C <sup>TM</sup>	$OCX^{TM}$	RapidConfigure™	UHC™
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